

06-30-1998

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To the Honorable Commissioner of Pat

100750603

3 attached original documents or copy thereof.

1. Name of conveying party(ies):

Akira Nakahira

Additional names(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Fuji Electric Co., Ltd.

Address:

1-1 Tanabeshinden, Kawasaki-ku,
Kawasaki 210, Japan

City: State/Prov.:

Country: ZIP:

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other

Execution Date: June 9, 1998

4. Application number(s) or registration numbers(s)

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No. Filing date

09/082,480 May 21, 1998

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: KANESAKA & TAKEUCHI

Registration No. 31,467

Address: 1423 Powhatan Street

06/25/1998 KANESAKA & TAKEUCHI 09082480 State/Prov.: VA

03 FC-581 Country: U.S.A. 40.00 ZIP: 22314

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$ 40.00

☒ Enclosed☐ Authorized to be charged to deposit account

8. Deposit account number:

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Manabu Kanesaka

Name of Person Signing

Signature

PATENT

Date

Total number of pages including cover sheet, attachments and document: 698

REEL: 9266 FRAME: 698

ASSIGNMENT

For value received, I, Akira Nakahira
having post office address at c/o Fuji Electric Co., Ltd.,
1-1 Tanabeshinden, Kawasaki-ku, Kawasaki 210, Japan
hereby sell, assign and transfer to Fuji Electric Co., Ltd.
a corporation existing under the laws of Japan
located at 1-1 Tanabeshinden, Kawasaki-ku, Kawasaki 210, Japan
and its successors, assigns, and legal representatives the entire
right, title, and interest for all countries including the United
States of America, in and to certain inventions relating to _____
SEMICONDUCTOR DEVICE WITH REDUCED AMOUNT OF SEALING RESIN
described in application for Letters Patent of the United States,
Serial No. 09/082,480 Filed May 21, 1998
and all patents which may be granted therefor, and all divisions,
reissues, continuations and extensions thereof, and authorize and
request the Commissioner of Patents to issue all patents on said
improvements or resulting therefrom to said Company as assignee of
the entire interest, and covenant that I/We have full right so to
do, and agree that I/We will communicate to said Company or its
representatives any facts known to me/us respecting said
improvements and testify in any legal proceedings, sign all lawful
papers, execute all divisional, continuing and reissue
applications, make all rightful oaths and generally do everything
possible to aid said Company, its successors, assigns, and
nominees, to obtain and enforce proper protection for said
invention in the United States.

Signature  Date June 9, 1998
Akira Nakahira

PATENT

RECORDED: 06/19/1998

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